ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Gate–Source Breakdown Voltage ($I_G = 1.0 \mu Adc, V_{DS} = 0$)		V _{(BR)GSS}	30	_	Vdc
Gate Reverse Current $(V_{GS} = 15 \text{ Vdc}, V_{DS} = 0, T_A = 25^{\circ}\text{C})$ $(V_{GS} = 15 \text{ Vdc}, V_{DS} = 0, T_A = 100^{\circ}\text{C})$		lgss	_ _	1.0 0.20	nAdc μAdc
Gate-Source Cutoff Voltage (V _{DS} = 15 Vdc, I _D = 10 nAdc)	MMBF4391LT1 MMBF4392LT1 MMBF4393LT1	V _{GS(off)}	-4.0 -2.0 -0.5	-10 -5.0 -3.0	Vdc
Off-State Drain Current $(V_{DS} = 15 \text{ Vdc}, V_{GS} = -12 \text{ Vdc})$ $(V_{DS} = 15 \text{ Vdc}, V_{GS} = -12 \text{ Vdc}, T_A = 100^{\circ}\text{C})$		I _{D(off)}		1.0 1.0	nAdc μAdc
ON CHARACTERISTICS					
Zero-Gate-Voltage Drain Current $(V_{DS} = 15 \text{ Vdc}, V_{GS} = 0)$	MMBF4391LT1 MMBF4392LT1 MMBF4393LT1	I _{DSS}	50 25 5.0	150 75 30	mAdc
$ \begin{array}{l} \text{Drain-Source On-Voltage} \\ \text{(I}_{D} = 12 \text{ mAdc, V}_{GS} = 0) \\ \text{(I}_{D} = 6.0 \text{ mAdc, V}_{GS} = 0) \\ \text{(I}_{D} = 3.0 \text{ mAdc, V}_{GS} = 0) \end{array} $	MMBF4391LT1 MMBF4392LT1 MMBF4393LT1	V _{DS(on)}	- - -	0.4 0.4 0.4	Vdc
Static Drain–Source On–Resistance ($I_D = 1.0 \text{ mAdc}, V_{GS} = 0$)	MMBF4391LT1 MMBF4392LT1 MMBF4393LT1	r _{DS(on)}	- - -	30 60 100	Ω
SMALL-SIGNAL CHARACTERISTICS			•	•	
Input Capacitance (V _{DS} = 15 Vdc, V _{GS} = 0, f = 1.0 MHz)		C _{iss}	_	14	pF
Reverse Transfer Capacitance (V _{DS} = 0, V _{GS} = 12 Vdc, f = 1.0 MHz)		C _{rss}	_	3.5	pF

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MMBF4391LT1	6J	SOT-23	
MMBF4391LT1G	6J	SOT-23 (Pb-Free)	
MMBF4392LT1	6K	SOT-23	
MMBF4392LT1G	6K	SOT-23 (Pb-Free)	3000 / Tape & Reel
MMBF4393LT1	6G	SOT-23	
MMBF4393LT1G	6G	SOT-23 (Pb-Free)	

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

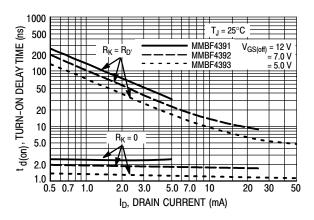


Figure 1. Turn-On Delay Time

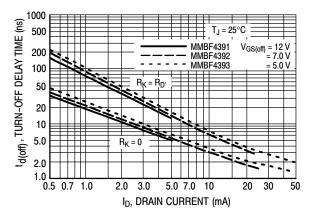


Figure 3. Turn-Off Delay Time

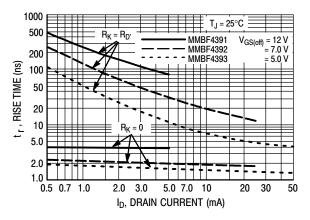


Figure 2. Rise Time

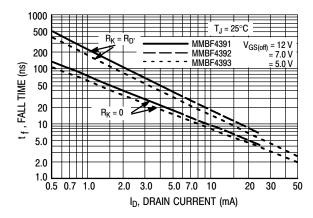


Figure 4. Fall Time

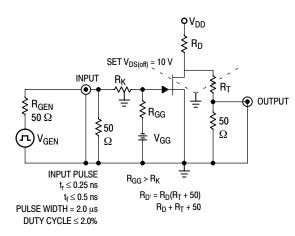


Figure 5. Switching Time Test Circuit

NOTE 1

The switching characteristics shown above were measured using a test circuit similar to Figure 5. At the beginning of the switching interval, the gate voltage is at Gate Supply Voltage ($-V_{GG}$). The Drain–Source Voltage (V_{DS}) is slightly lower than Drain Supply Voltage (V_{DD}) due to the voltage divider. Thus Reverse Transfer Capacitance (C_{rss}) of Gate–Drain Capacitance (C_{gd}) is charged to $V_{GG} + V_{DS}$.

During the turn–on interval, Gate–Source Capacitance (C_{gs}) discharges through the series combination of R_{Gen} and R_K . C_{gd} must discharge to $V_{DS(on)}$ through R_G and R_K in series with the parallel combination of effective load impedance (R'_D) and Drain–Source Resistance (r_{DS}). During the turn–off, this charge flow is reversed.

Predicting turn—on time is somewhat difficult as the channel resistance r_{DS} is a function of the gate—source voltage. While C_{gs} discharges, V_{GS} approaches zero and r_{DS} decreases. Since C_{gd} discharges through r_{DS} , turn—on time is non—linear. During turn—off, the situation is reversed with r_{DS} increasing as C_{gd} charges.

The above switching curves show two impedance conditions; 1) R_K is equal to $R_{D^{\dagger}}$ which simulates the switching behavior of cascaded stages where the driving source impedance is normally the load impedance of the previous stage, and 2) $R_K = 0$ (low impedance) the driving source impedance is that of the generator.

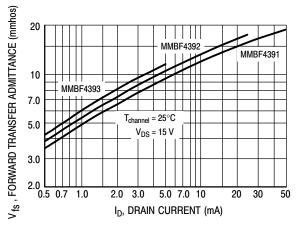


Figure 6. Typical Forward Transfer Admittance

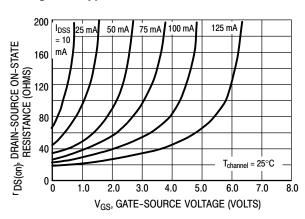


Figure 8. Effect of Gate-Source Voltage on Drain-Source Resistance

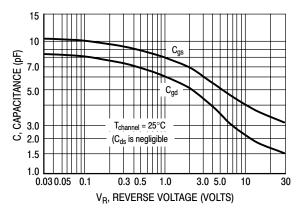


Figure 7. Typical Capacitance

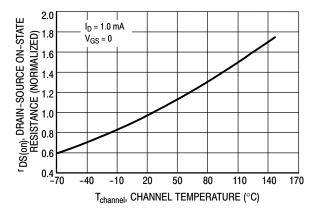


Figure 9. Effect of Temperature on Drain–Source On–State Resistance

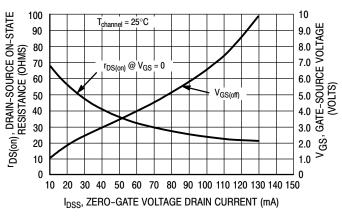


Figure 10. Effect of I_{DSS} on Drain-Source Resistance and Gate-Source Voltage

NOTE 2

The Zero–Gate–Voltage Drain Current (I_{DSS}) is the principle determinant of other J–FET characteristics. Figure 10 shows the relationship of Gate–Source Off Voltage ($V_{GS(off)}$) and Drain–Source On Resistance ($r_{DS(on)}$) to I_{DSS} . Most of the devices will be within $\pm 10\%$ of the values shown in Figure 10. This data will be useful in predicting the characteristic variations for a given part number.

For example:

Unknown

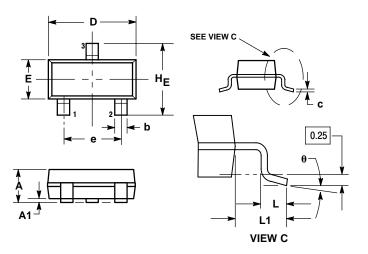
r_{DS(on)} and V_{GS} range for an MMBF4392

The electrical characteristics table indicates that an MMBF4392 has an I_{DSS} range of 25 to 75 mA. Figure 10 shows $r_{DS(on)}$ = 52 Ω for I_{DSS} = 25 mA and 30 Ω for I_{DSS} = 75 mA. The corresponding V_{GS} values are 2.2 V and 4.8 V.

PACKAGE DIMENSIONS

SOT-23 (TO-236)

CASE 318-08 ISSUE AN



NOTES:

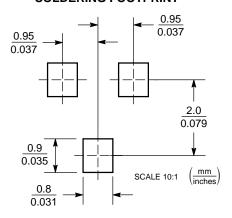
- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF
- BASE MATERIAL. 318–01 THRU –07 AND –09 OBSOLETE, NEW STANDARD 318-08.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
Е	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 10:

- PIN 1. DRAIN 2. SOURCE
 - GATE

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D

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